

## 500mA Current Limited Power Switch

Check for Samples: [LM34904](#)

### FEATURES

- Input Voltage of 2.8V to 5.3V
- 0.5A Maximum Switch Current
- 0.4Ω Typical Total On-Resistance
- Load Detection
- Enable/Disable
- Switch On Indicator
- Peak Current Limit
- Thermal Shutdown
- 6-bump Thin DSBGA Package

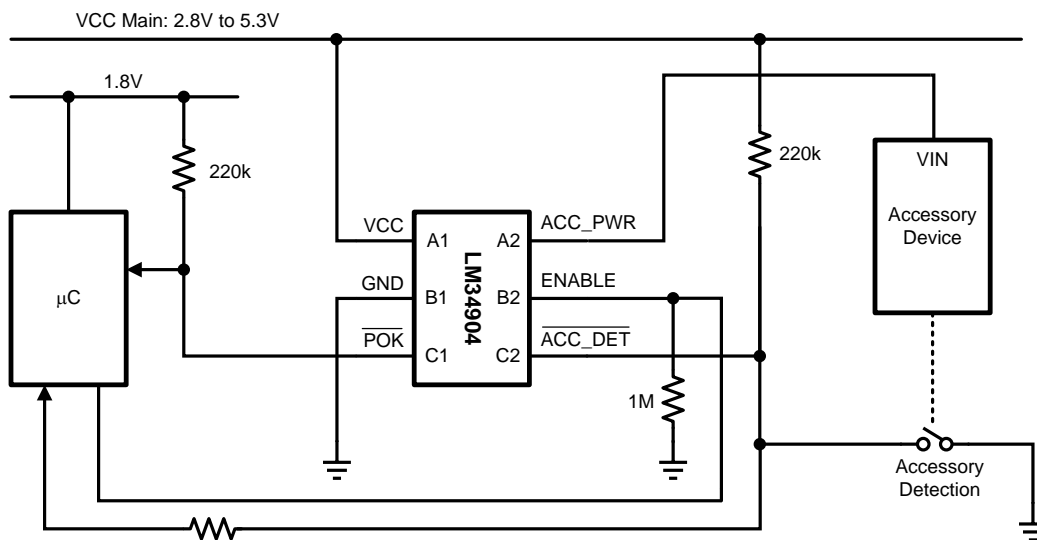
### DESCRIPTION

The LM34904 is a 0.5A PFET switch used to control the input voltage of electronic devices. It is easily integrated into system designs that have a 2.8V to 5.3V voltage rail. Besides the 0.4Ω PFET switch, the LM34904 can be enabled or disabled by a logic signal. The IC monitors the presence of a downstream electronic device via a dedicated pin to decide whether to turn on the PFET switch. A power good signal generated by the IC can be used by system control to determine the status of the switch. The LM34904 also provides over-current and over-temperature protection. The IC comes in a tiny 6-bump thin DSBGA package.

### APPLICATIONS

- Handsets, Tablets, Notebooks
- Portable Devices

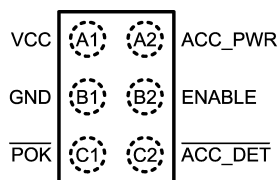
### Typical Application Circuit



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## Connection Diagram



**Figure 1. Top View - 6-Bump Thin DSBGA Package**  
See Package Number YFQ

### PIN DESCRIPTIONS

Name	Pin Number	Function
VCC	A1	Power input of the PFET switch. It also provides power to the entire IC. Connect to the voltage rail that the accessory device is expected to work off.
GND	B1	Common Ground (device substrate).
$\overline{\text{POK}}$	C1	Open-drain PFET status indicator. When the PFET is off, this pin floats. When PFET is on, it is grounded.
$\overline{\text{ACC\_DET}}$	C2	Pull this pin low to tell the IC that the downstream accessory device is plugged in.
ENABLE	B2	When this pin is low, the PFET will be turned off and $\overline{\text{POK}}$ will be open-drained. Current limit circuitry will also be disabled. The IC will be in a low-power state. This pin should be held low until VCC is established to ensure proper initial state of internal logic. When ENABLE is high, the PFET switch will be allowed to turn on.
ACC_PWR	A2	Power output terminal of the PFET switch. Connect to input rail of accessory device.

### Truth Table<sup>(1)</sup>

Input					Output	
ENABLE	$\overline{\text{ACC\_DET}}$	Current Limit Detected	T <sub>J</sub> Limit Exceeded	2.8V < VCC < 5.3V	PFET Switch Status	$\overline{\text{POK}}$
0	x	No	No	Yes	Open	Open Drain
x	1	No	No	Yes	Open	Open Drain
0 to 1	0	No	No	Yes	On	Grounded
0 to 1	0	Yes	No	Yes	Current Limited	Grounded
x	x	x	Yes	2.2V < VCC < 5.3V	Open	Open Drain
0	x	x	No	2.2V < VCC < 2.8V	Open	Open Drain

(1) Note: "x" stands for "don't care".



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## Absolute Maximum Ratings<sup>(1)(2)</sup>

VCC	-0.3V to 6V
ENABLE, $\overline{\text{POK}}$ , $\overline{\text{ACC\_DET}}$ , ACC_PWR <sup>(3)</sup>	-0.3V to 6V
Junction Temperature (T <sub>J</sub> )	+150°C
Storage Temperature Range	-65°C to +150°C
ESD Susceptibility, Human Body Model <sup>(4)</sup>	2kV

- (1) Absolute Maximum Ratings are limits beyond which damage to the device may occur. Operating Ratings are conditions under which operation of the device is ensured. Operating Ratings do not imply ensured performance limits. For ensured performance limits and associated test conditions, see the Electrical Characteristics table.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
- (3) The voltages on these pins should never exceed VCC+0.3V.
- (4) The human body model is a 100 pF capacitor discharged through a 1.5 kΩ resistor into each pin. Test method is per JESD-22-A114.

## Operating Ratings

VCC Voltage <sup>(1)</sup>	2.8V to 5.3V
Junction Temperature (T <sub>J</sub> ), LM34904	-40°C to +85°C

- (1) For VCC between 2.2V and 2.8V, if ENABLE is a logic low, the LM34904 will not turn on the PFET switch.

## Electrical Characteristics

Unless otherwise stated, the following conditions apply: VCC = 3V. Limits in standard type are for T<sub>J</sub> = 25°C only; limits in **boldface type** apply over the operating junction temperature (T<sub>J</sub>) range. Minimum and maximum limits are ensured through test, design, or statistical correlation. Typical values represent the most likely parametric norm at T<sub>J</sub> = 25°C and are provided for reference purposes only.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V <sub>IL</sub>	Input Low Voltage, $\overline{\text{ACC\_DET}}$ , ENABLE				<b>0.45</b>	V
V <sub>IH</sub>	Input High Voltage, $\overline{\text{ACC\_DET}}$ , ENABLE		<b>1.35</b>			V
V <sub>IHS</sub>	Input Hysteresis, $\overline{\text{ACC\_DET}}$ , ENABLE			55		mV
I <sub>LK</sub>	Input Current, $\overline{\text{ACC\_DET}}$ , ENABLE	$\overline{\text{ACC\_DET}}$ , ENABLE between 0V and VCC			1	μA
I <sub>SD</sub>	VCC Current in Shutdown Mode	V <sub>ENABLE</sub> = 0V V <sub>VCC</sub> = 5.3V		0.005	<b>1</b>	μA
I <sub>Q</sub>	VCC Quiescent Current	V <sub>ENABLE</sub> = 1.8V V <sub>VCC</sub> = 5.3V, I <sub>ACC_PWR</sub> = 0A		47	<b>100</b>	μA
R <sub>ON</sub>	Total On Resistance Between VCC and ACC_PWR Pins	V <sub>VCC</sub> = 2.8V to 5.3V I <sub>ACC_PWR</sub> = 0.5A		0.4	<b>0.6</b>	Ω
I <sub>LK_ACC</sub>	ACC_PWR Leakage Current When PFET is Off	V <sub>ACC_PWR</sub> = 0V to VCC V <sub>VCC</sub> = 5.3V V <sub>ENABLE</sub> = 0V			1	μA
I <sub>LIMIT</sub>	PFET Switch Current Limit	V <sub>VCC</sub> = 2.8V to 5.3V V <sub>ACC_PWR</sub> = 0V	<b>0.50</b>	0.59	<b>0.76</b>	A
V <sub>POK</sub>	$\overline{\text{POK}}$ Current Sink Capability	$\overline{\text{POK}}$ asserted. 1mA sink current			0.4	V
I <sub>POK</sub>	$\overline{\text{POK}}$ Leakage Current	$\overline{\text{POK}}$ de-asserted V <sub><math>\overline{\text{POK}}</math></sub> = 3.3V			1	μA
T <sub>1</sub>	$\overline{\text{ACC\_DET}}$ Response Time	$\overline{\text{ACC\_DET}}$ rising to either PFET or $\overline{\text{POK}}$ FET turn-off		107		ns
T <sub>2</sub>	ENABLE Response Time	ENABLE rising to either PFET or $\overline{\text{POK}}$ FET turn-on		10		μs
T <sub>3</sub>	Minimum ENABLE Cycle Time <sup>(1)</sup>	$\overline{\text{ACC\_DET}}$ tied to ground. ENABLE logic high = 1.8V. VCC = 2.8V to 5.3V.		300		ns

- (1) If ENABLE toggles low from a high state, it needs to stay low for at least T<sub>3</sub> long before toggling back to high. Otherwise the internal flip-flop may not be set and the PFET switch may not turn on.

**Thermal Characteristics**

Symbol	Description	Conditions	Typical Value	Unit
$\theta_{JA1}$	Junction-to-Ambient Thermal Resistance	Mount device on a standard 4-layer 4" x 3" JEDEC board. Apply known amount of power to the package. Measure junction temperature and surrounding air temperature. No air flow. Refer to JESD51-7 for more information.	104	°C/W
$\theta_{JA2}$	Junction-to-Ambient Thermal Resistance	Mount device on a 2-layer 2.19" x 2.9" board. Copper thickness is 1 oz per layer. No air flow. Power dissipation is 0.5W.	136	°C/W
$T_{SD}$	Thermal Shutdown Threshold	Raise $T_J$ from below 120°C until $\overline{POK}$ is de-asserted. No load is connected at ACC_PWR.	135	°C

## Typical Performance Characteristics

Unless indicated otherwise,  $V_{CC} = 3.0V$  and  $T_J = 25^\circ C$ .

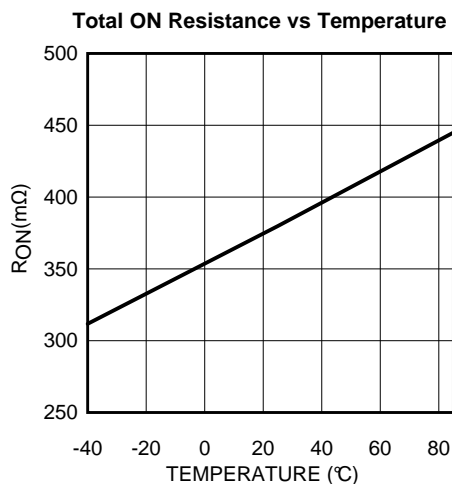


Figure 2.

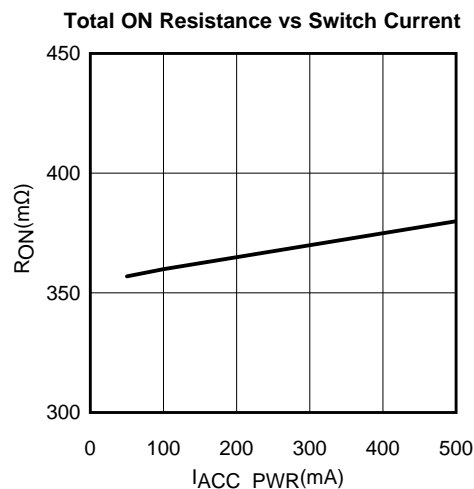


Figure 3.

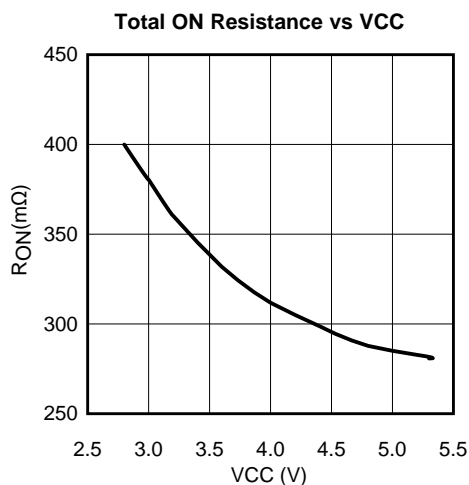


Figure 4.

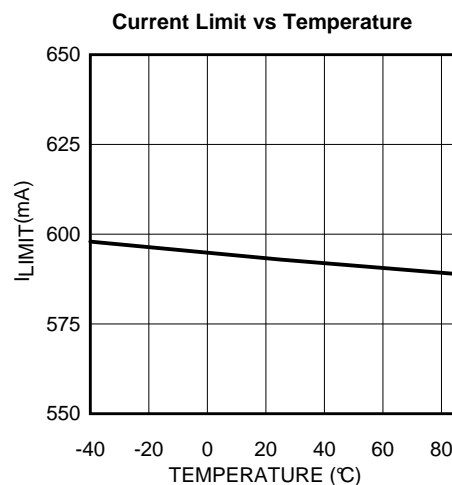


Figure 5.

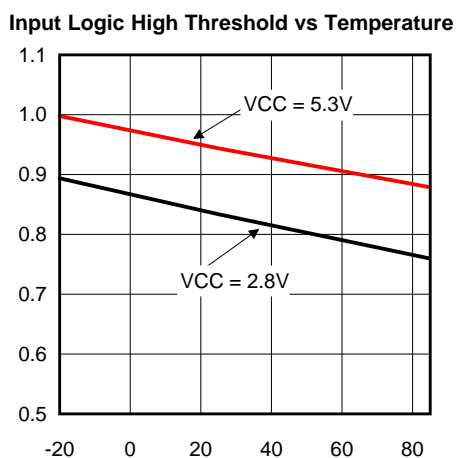


Figure 6.

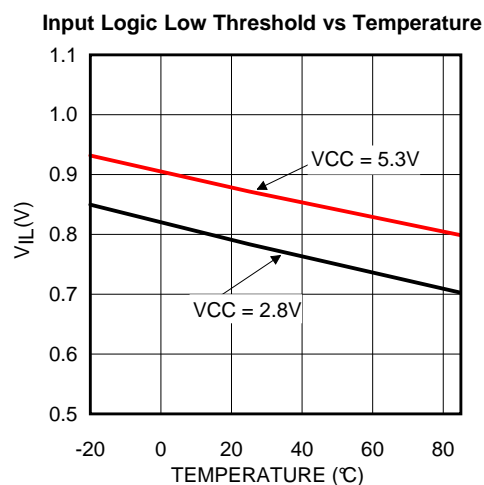
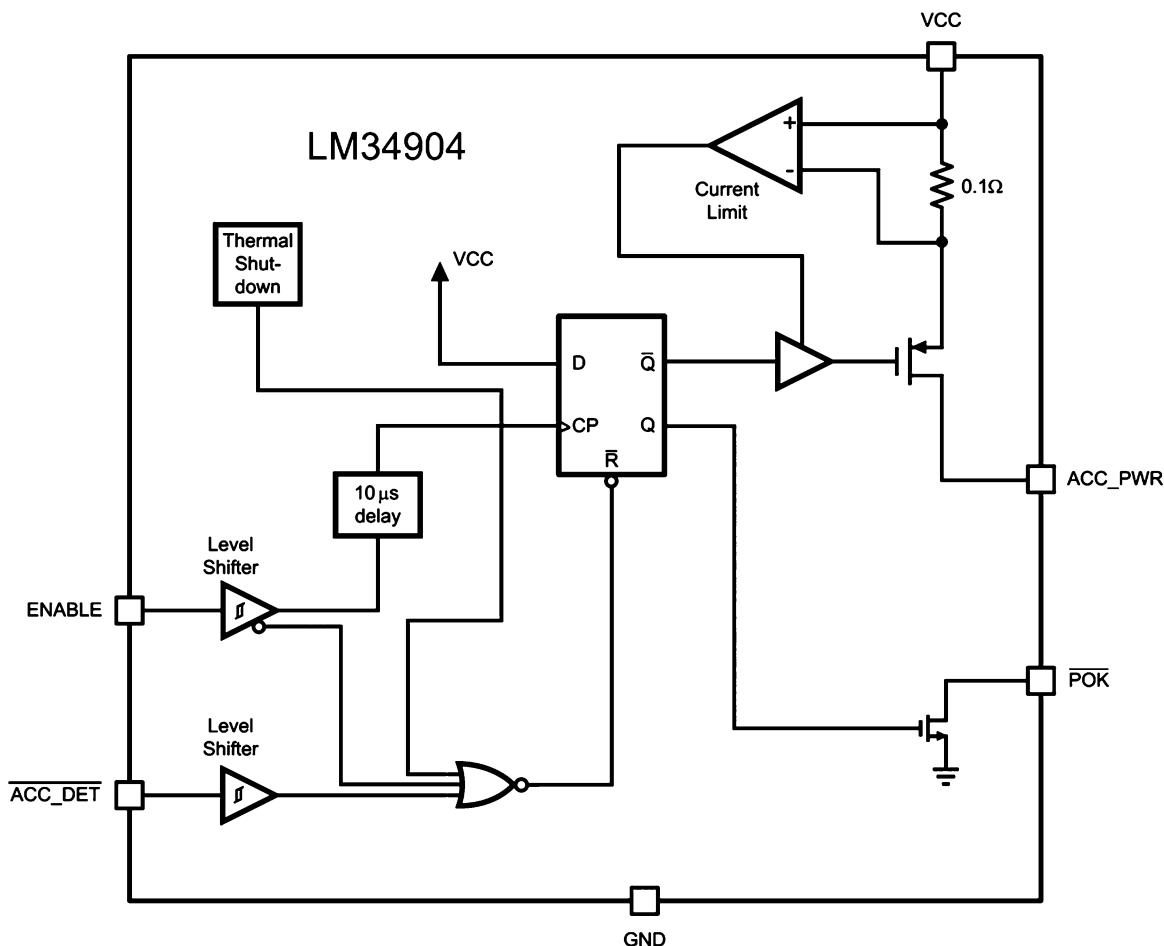


Figure 7.

## BLOCK DIAGRAM



## APPLICATION HINTS

To turn on the PFET switch, both the ENABLE and the  $\overline{\text{ACC\_DET}}$  pins need to be asserted. In addition,  $\overline{\text{ACC\_DET}}$  needs to be asserted no later than the rising edge of the ENABLE signal. De-assertion of either the ENABLE or the  $\overline{\text{ACC\_DET}}$  will result in turned-off PFET switch and de-asserted POK signal.

To prevent a glitch in the otherwise asserted  $\overline{\text{ACC\_DET}}$  from keeping the FETs turned off, it is a good practice to cycle the ENABLE following every falling edge in the  $\overline{\text{ACC\_DET}}$  signal. When cycling the ENABLE, make sure it stays low for at least  $T_3$  long before toggling back high. If ENABLE logic high level is not 1.8V, make sure ENABLE stays low for at least 1 μs.

When laying out the PCB, try to keep the ENABLE and  $\overline{\text{ACC\_DET}}$  traces as short as possible and away from noisy traces.

## REVISION HISTORY

Changes from Revision D (April 2013) to Revision E	Page
• Changed layout of National Data Sheet to TI format .....	<a href="#">6</a>

## PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">LM34904ITM/NOPB</a>	Active	Production	DSBGA (YFQ)   6	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	L
LM34904ITM/NOPB.A	Active	Production	DSBGA (YFQ)   6	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	L
<a href="#">LM34904ITMX/NOPB</a>	Active	Production	DSBGA (YFQ)   6	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	L
LM34904ITMX/NOPB.A	Active	Production	DSBGA (YFQ)   6	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	L

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM34904ITM/NOPB	DSBGA	YFQ	6	250	178.0	8.4	0.89	1.3	0.7	4.0	8.0	Q1
LM34904ITMX/NOPB	DSBGA	YFQ	6	3000	178.0	8.4	0.89	1.3	0.7	4.0	8.0	Q1

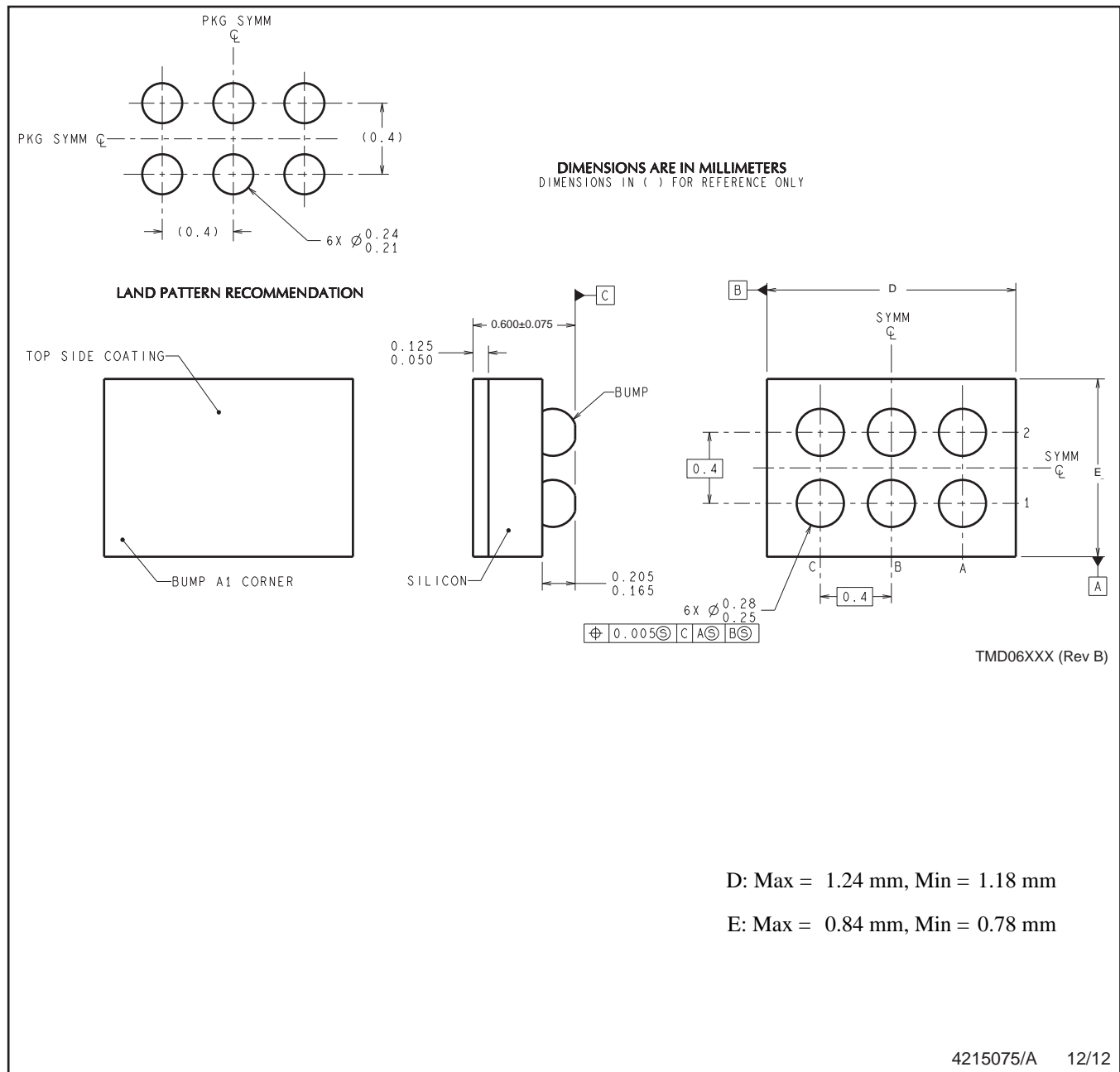
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM34904ITM/NOPB	DSBGA	YFQ	6	250	208.0	191.0	35.0
LM34904ITMX/NOPB	DSBGA	YFQ	6	3000	208.0	191.0	35.0

YFQ0006



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.  
B. This drawing is subject to change without notice.

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